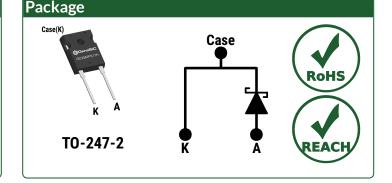
Silicon Carbide Schottky Diode



V <sub>RRM</sub> =	1700 V
I <sub>F(Tc</sub> = 156°C) =	25 A
Qc =	206 nC

### Features

- Gen4 Thin Chip Technology for Low V<sub>F</sub>
- Enhanced Surge and Avalanche Robustness
- Superior Figure of Merit Q<sub>C</sub>/I<sub>F</sub>
- Low Thermal Resistance
- Low Reverse Leakage Current
- Temperature Independent Fast Switching
- Positive Temperature Coefficient of  $V_{\text{F}}$
- Low V<sub>F</sub> for High Temperature Operation



## Advantages

- Improved System Efficiency
- High System Reliability
- Optimal Price Performance
- Reduced Cooling Requirements
- Increased System Power Density
- Zero Reverse Recovery Current
- Easy to Parallel without Thermal Runaway
- Improved System Efficiency

### Applications

- EV Fast Chargers
- Solar Inverters
- Wind Energy Converters
- Train Auxiliary Power Supplies
- High Frequency Rectifiers
- Switched Mode Power Supplies
- Motor Drives
- Pulsed Power

### Absolute Maximum Ratings (At Tc = 25°C Unless Otherwise Stated)

Parameter	Symbol	Conditions	Values	Unit	Note
Repetitive Peak Reverse Voltage	V <sub>RRM</sub>		1700	V	
		T <sub>C</sub> = 100°C, D = 1	56		
Continuous Forward Current	IF	T <sub>C</sub> = 135°C, D = 1	39	Α	Fig. 4
		T <sub>C</sub> = 156°C, D = 1	25		
Non-Repetitive Peak Forward Surge Current, Half Sine	l=	T <sub>C</sub> = 25°C, t <sub>P</sub> = 10 ms	250	٨	
Wave	IF,SM	T <sub>C</sub> = 150°C, t <sub>P</sub> = 10 ms	200	A	
Repetitive Peak Forward Surge Current, Half Sine Wave		T <sub>C</sub> = 25°C, t <sub>P</sub> = 10 ms	150	Α	
Repetitive Peak Forward Surge Current, Han Sine Wave	IF,RM	T <sub>C</sub> = 150°C, t <sub>P</sub> = 10 ms	105	А	
Non-Repetitive Peak Forward Surge Current	I <sub>F,MAX</sub>	T <sub>C</sub> = 25°C, t <sub>P</sub> = 10 μs	1250	Α	
i <sup>2</sup> t Value	∫i²dt	T <sub>C</sub> = 25°C, t <sub>P</sub> = 10 ms	312	A <sup>2</sup> s	
Non-Repetitive Avalanche Energy	E <sub>AS</sub>	L = 1.6 mH, I <sub>AS</sub> = 25 A	500	mJ	
Diode Ruggedness	dV/dt	V <sub>R</sub> = 0 ~ 1360 V	200	V/ns	
Power Dissipation	Ртот	T <sub>C</sub> = 25°C	425	W	Fig. 3
Operating and Storage Temperature	Tj, Tstg		-55 to 175	°C	





## **Electrical Characteristics**

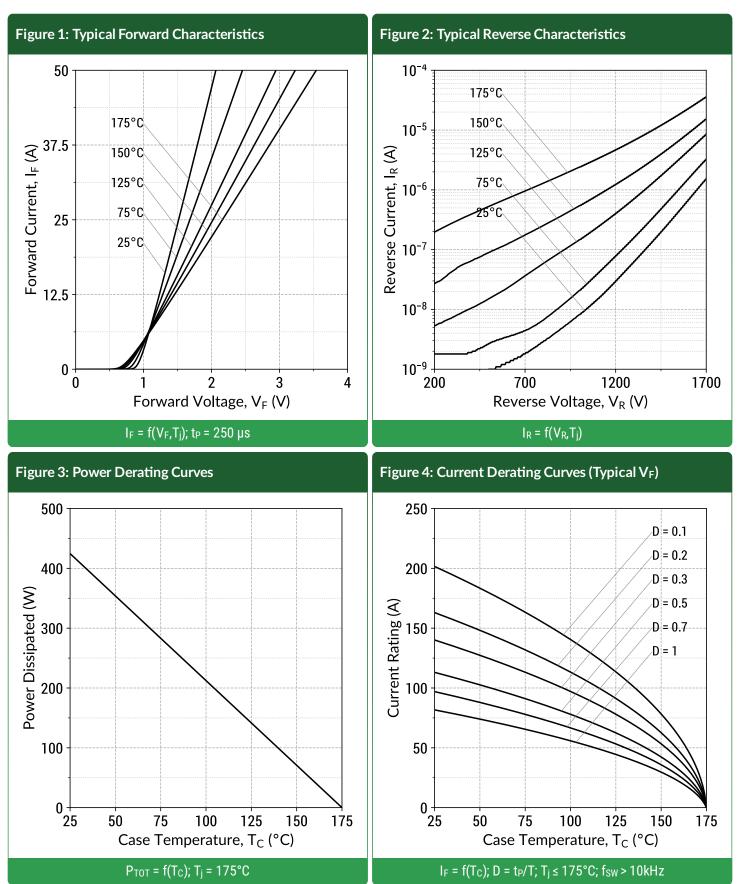
Parameter	Symbol	Conditions -		Values		11	Nete	
Parameter	Symbol			Min.	Тур.	Max.	Unit	Note
Diada Farward Valtaga	VF	I <sub>F</sub> = 25 A, T <sub>j</sub> = 25°C			1.5	1.8	V	Fig. 1
Diode Forward Voltage	VF	I <sub>F</sub> = 25 A, T <sub>j</sub> = 175°C			2.1			
Reverse Current	la la	V <sub>R</sub> = 1700 V, T <sub>j</sub> = 25°C V <sub>R</sub> = 1700 V, T <sub>j</sub> = 175°C			1	20		Fig. 2
	IR				16		μA	
Total Capacitive Charge	0		V <sub>R</sub> = 600 V		141		nC	Fig. 7
	Qc	I <sub>F</sub> ≤ I <sub>F,MAX</sub>	V <sub>R</sub> = 1200 V		206			
Switching Time	+	dl <sub>F</sub> /dt = 200 A/µs	V <sub>R</sub> = 600 V		. 10			
	ts	V <sub>R</sub> = 1200 V			< 10		ns	
Tatal Canaditanaa	0	V <sub>R</sub> = 1 V, f =	= 1MHz		1803		ъГ	
Total Capacitance	С	V <sub>R</sub> = 1200 V, f = 1MHz			99	pF		Fig. 6

## Thermal/Package Characteristics

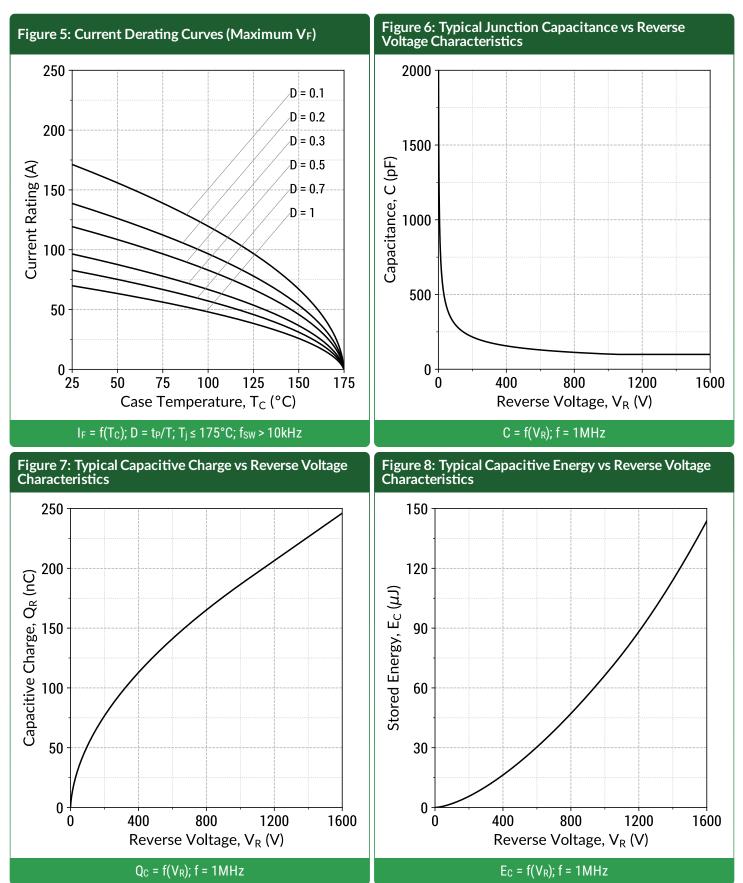
Deremeter	Cumbol	Conditions		Values		l Init	Note
Parameter	Symbol	Conditions	Min.	Тур.	Max.	<b>Unit</b>	Note
Thermal Resistance, Junction - Case	RthJC			0.35		°C/W	Fig. 9
Weight	WT			6.0		g	
Mounting Torque	Тм	Screws to Heatsink			1.1	Nm	











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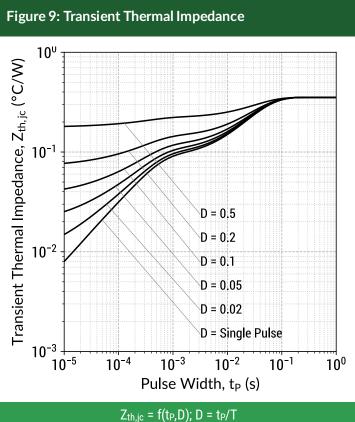


Figure 10: Forward Curve Model Forward Current, I<sub>F</sub> (A) 1/RDIFF VBI \ Forward Voltage,  $V_F$  (V)

 $I_F = f(V_F, T_j)$ 

### Forward Curve Model Equation:

 $I_F = (V_F - V_{BI})/R_{DIFF} (A)$ 

Built-In Voltage (V<sub>BI</sub>):

 $V_{BI}(T_i) = m \times T_i + n (V)$ m = -0.00126 (V/°C)n = 0.997 (V)

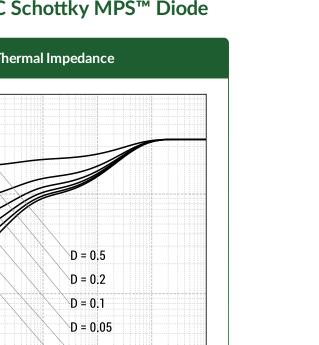
Differential Resistance (RDIFF):

 $R_{DIFF}(T_i) = a \times T_i^2 + b \times T_i + c(\Omega)$ a =  $4.08e-07 (\Omega/^{\circ}C^2)$ **b** = 0.000141 ( $\Omega$ /°C) **c** = 0.0182 (Ω)

**Forward Power Loss Equation:** 

 $P_{LOSS} = V_{BI}(T_i) \times I_{AVG} + R_{DIFF}(T_i) \times I_{RMS}^2$ 

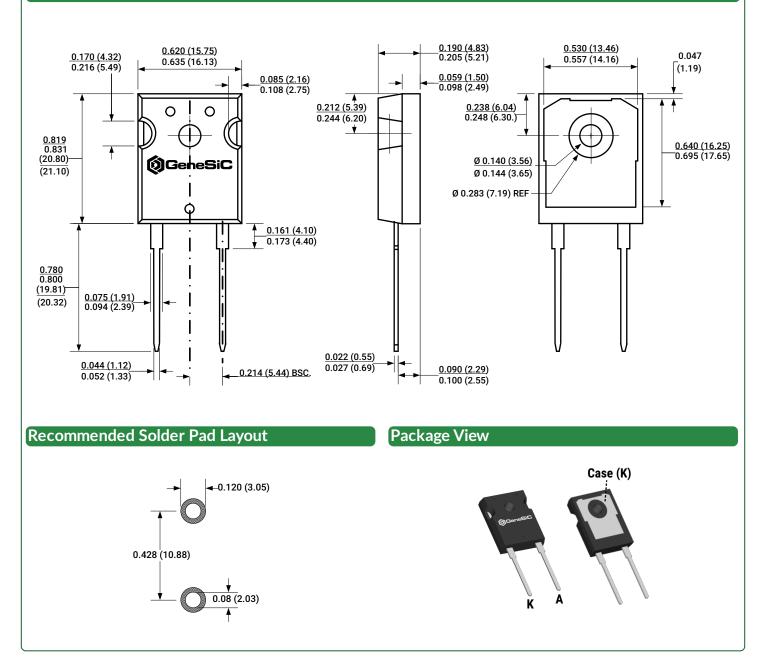






## Package Dimensions

## TO-247-2 Package Outline



#### NOTE

- 1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
- 2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS.



# GD25MPS17H 1700V 25A SiC Schottky MPS™ Diode



### Compliance

#### **RoHS Compliance**

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS 2), as adopted by EU member states on January 2, 2013 and amended on March 31, 2015 by EU Directive 2015/863. RoHS Declarations for this product can be obtained from your GeneSiC representative.

#### **REACH Compliance**

REACH substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact a GeneSiC representative to insure you get the most up-to-date REACH SVHC Declaration. REACH banned substance information (REACH Article 67) is also available upon request.

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### **Related Links**

SPICE Models:	https://www.genesicsemi.	com/sic-schottky-mps/GD2	25MPS17H/GD25MPS17H_SPICE.zip

- PLECS Models: https://www.genesicsemi.com/sic-schottky-mps/GD25MPS17H/GD25MPS17H\_PLECS.zip
- CAD Models: https://www.genesicsemi.com/sic-schottky-mps/GD25MPS17H/GD25MPS17H\_3D.zip
- · Evaluation Boards: https://www.genesicsemi.com/technical-support
- Reliability: https://www.genesicsemi.com/reliability
- Compliance: https://www.genesicsemi.com/compliance
- Quality Manual: https://www.genesicsemi.com/quality

### **Revision History**

- Rev 21/Jun: Updated with most recent test data
- Supersedes: Rev 20/Jul



## www.genesicsemi.com/sic-schottky-mps/



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